

# 1A, 50V - 1000V High Efficient Bridge Rectifier

#### **FEATURES**

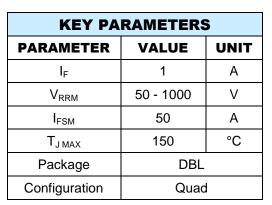
- Glass passivated chip junction
- Ideal for printed circuit board
- · Reliable low cost construction utilizing molded plastic technique
- · High surge current capability
- UL Recognized File # E-326854
- AEC-Q101 qualified available
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- Switching mode power supply (SMPS)
- Adapters
- Lighting application

#### **MECHANICAL DATA**

- Case: DBL
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.360g (approximately)



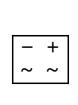


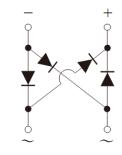






**DBL** 





ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)									
PARAMETER	SYMBOL	HDBL 101G	HDBL 102G	HDBL 103G	HDBL 104G	HDBL 105G	HDBL 106G	HDBL 107G	UNIT
Marking code on the device		HDBL 101G	HDBL 102G	HDBL 103G	HDBL 104G	HDBL 105G	HDBL 106G	HDBL 107G	
Repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	35	70	140	280	420	560	700	V
Forward current	I <sub>F</sub>	1					Α		
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	50					А		
Rating for fusing (t<8.3ms)	l <sup>2</sup> t	10.3					A <sup>2</sup> s		
Junction temperature	TJ	- 55 to +150				°C			
Storage temperature	T <sub>STG</sub>	- 55 to +150					°C		

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THERMAL PERFORMANCE						
PARAMETER	SYMBOL	ТҮР	UNIT			
Junction-to-lead thermal resistance	R <sub>OJL</sub>	15	°C/W			
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	40	°C/W			

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode <sup>(1)</sup>	HDBL101G HDBL102G HDBL103G	I <sub>F</sub> = 1A, T <sub>J</sub> = 25°C	V <sub>F</sub>	-	1.0	V
	HDBL104G			-	1.3	V
	HDBL105G HDBL106G HDBL107G			-	1.7	V
Reverse current @ rated V <sub>R</sub> per diode <sup>(2)</sup>		T <sub>J</sub> = 25°C	,	-	5	μA
		T <sub>J</sub> = 125°C	l <sub>R</sub>	-	500	μA
Reverse recovery time	HDBL101G HDBL102G HDBL103G HDBL104G	$I_F = 0.5A, I_R = 1.0A,$ $I_{rr} = 0.25A$	t <sub>rr</sub>	-	50	ns
	HDBL105G HDBL106G HDBL107G				75	ns

## Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION						
ORDERING CODE <sup>(1)(2)</sup>	PACKAGE	PACKING				
HDBL10xG	DBL	50 / Tube				
HDBL10xGH	DBL	50 / Tube				

# Notes:

- 1. "x" defines voltage from 50V(HDBL101G) to 1000V(HDBL107G)
- 2. "H" means AEC-Q101 qualified



### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

**Fig.1 Forward Current Derating Curve** 

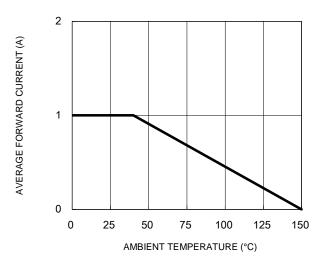
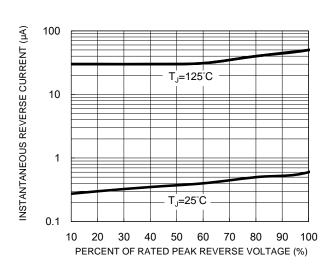


Fig.3 Typical Reverse Characteristics



**Fig.2 Typical Junction Capacitance** 

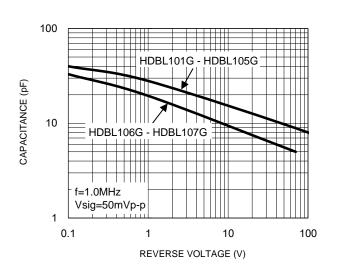


Fig.4 Typical Forward Characteristics

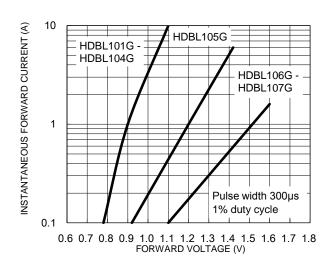
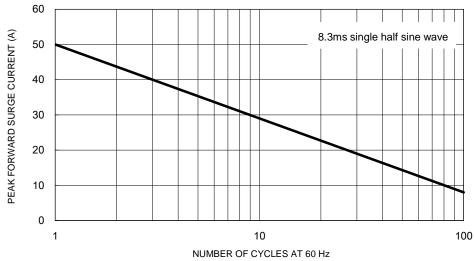


Fig.5 Maximum Non-Repetitive Forward Surge Current



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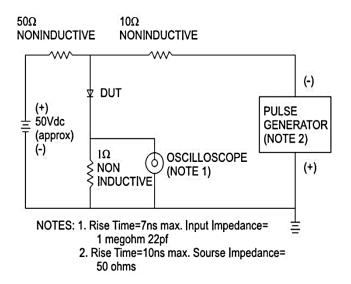


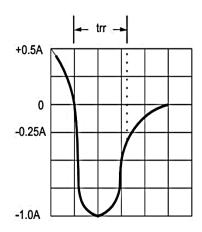
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## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram

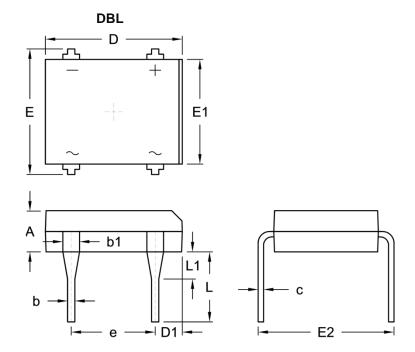






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## **PACKAGE OUTLINE DIMENSIONS**



DIM.	Unit	(mm)	Unit (inch)		
Dilvi.	Min.	Max.	Min.	Max.	
Α	2.40	2.60	0.094	0.102	
b	0.46	0.58	0.018	0.023	
b1	0.89	1.14	0.035	0.045	
С	0.22	0.33	0.009	0.013	
D	8.12	8.51	0.320	0.335	
D1	1.39	1.90	0.055	0.075	
е	5.00	5.20	0.197	0.205	
E	7.24	8.00	0.285	0.315	
E1	6.20	6.50	0.244	0.256	
E2	7.60	8.90	0.299	0.350	
L	3.81	4.69	0.150	0.185	
L1	1.27	2.03	0.050	0.080	

## **MARKING DIAGRAM**



P/N = Marking Code

G = Green Compound

YW = Date Code

F = Factory Code



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